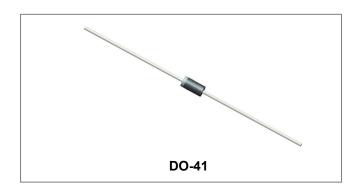






11DQ03/11DQ04 SCHOTTKY RECTIFIER



Features

- Low profile, axial leaded outline
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Very Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	30(11DQ03) 40(11DQ04)	V
Average Forward Current	I _{F(AV)}	50% duty cycle @T _L =75°C, rectangular wave form On PC board 9mm² island	1.1	А
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3 ms, half Sine pulse	40	Α

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V _{F1}	@ 1 A, Pulse, T _J = 25 °C	0.45	0.55	V
		@ 2 A, Pulse, T _J = 25 °C	-	0.71	V
	V_{F2}	@ 1 A, Pulse, T _J = 125 °C	0.35	0.50	V
		@ 2 A, Pulse, T _J = 125 °C	-	0.61	V
Reverse Current*	I _{R1}	@ V_R = Rated V_R , Pulse, T_J = 25 °C	0.007	1	mA
	I _{R2}	@ V_R = Rated V_R , Pulse, T_J = 125 °C	1.0	6	mA
Junction Capacitance	Ст	$@V_R = 5V, T_C = 25 \text{ °C}$ $f_{SIG} = 1MHz$	55	60	PF
Typical Series Inductance	Ls	Measured lead to lead 5 mm from package body	8.0	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

^{*} Pulse width < 300 µs, duty cycle < 2%

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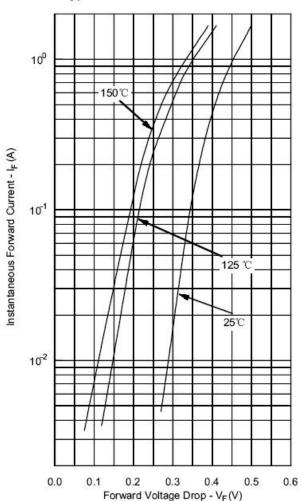


Thermal-Mechanical Specifications:

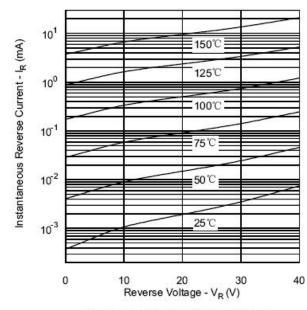
Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-40 to +150	°C
Storage Temperature	T _{stg}	-	-40 to +150	°C
Typical Thermal Resistance Junction to Ambient	R ₀ JA	-	100	°C/W
Typical Thermal Resistance Junction to Lead	R ₀ JL	-	81	°C/W
Approximate Weight	wt	-	0.34	g

Ratings and Characteristics Curves

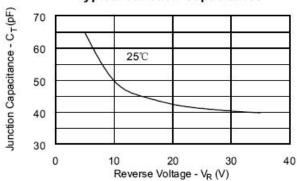
Typical Forward Characteristics



Typical Reverse Characteristics



Typical Junction Capacitance



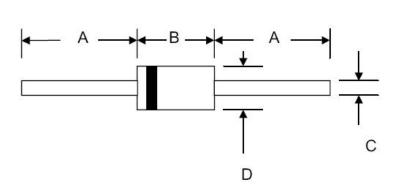
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Mechanical Dimensions DO-41



CVMDOI	Millimeters		Inches		
SYMBOL	Min.	Max.	Min.	Max.	
Α	25.4	-	1.000	-	
В	4.06	5.21	0.160	0.205	
С	0.71	0.864	0.028	0.034	
D	2.00	2.72	0.079	0.107	

Ordering Information

Device		Package	Shipping	
	11DQ03	DO-41 (Pb-Free)	5000pcs /reel	
	11DQ04	20 11 (1 0 1 100)	0000000071001	

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram

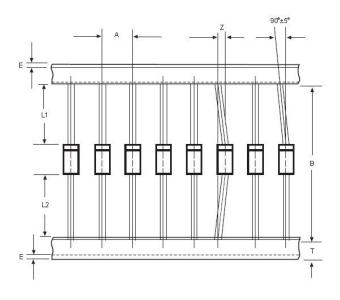
11DQ03 = Part Name
SSG = SSG
VV = Vear

YY = Year WW = Week L = Lot Number

Where XXXXX is YYWWL

Cautions: Molding resin Epoxy resin UL:94V-0

Carrier Tape Specification DO-41



SYMBOL	Millim	eters
STWIBUL	Min.	Max.
А	4.50	5.50
В	50.9	53.9
Z	-	1.20
Т	5.60	6.40
E	-	0.80
IL1-L2I	_	1.0

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